### TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

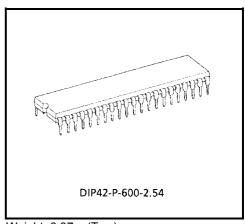
## **TD62824P**

### 8 × 3 PARALLEL SHIFT REGISTER / DRIVER

The TD62824P is a general purpose 24 bit driver IC consisting of 8 block 3 bit shift register and 24 bit driver (open collector). The TD62824P is best suited as a 24 dot printer head driver.

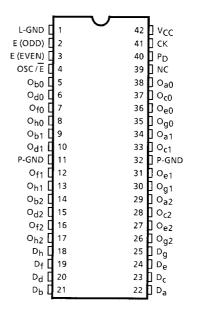
### **FEATURES**

- Power–down function for reducing power consumption during standby or when printing is not made. (ICC off < 10  $\mu A)$
- Independent 2 output enable terminals (even / add outputs)
- Effective as measures for regenerative effect during high-speed and high-density printing.
- 8bit parallel input and 3bit parallel shift configuration : High-speed operation and direct interface with CPU.
- Large output drive capacity
- Output with standing voltage ······ 30 V
  Output current ····· 80 mA DC
  150 mA 10%
- Built-in CR-Timer for load burning prevention.
- Less output saturation voltage difference in package
  : Within ±50mV (standard) at I<sub>OUT</sub> = 120 mA

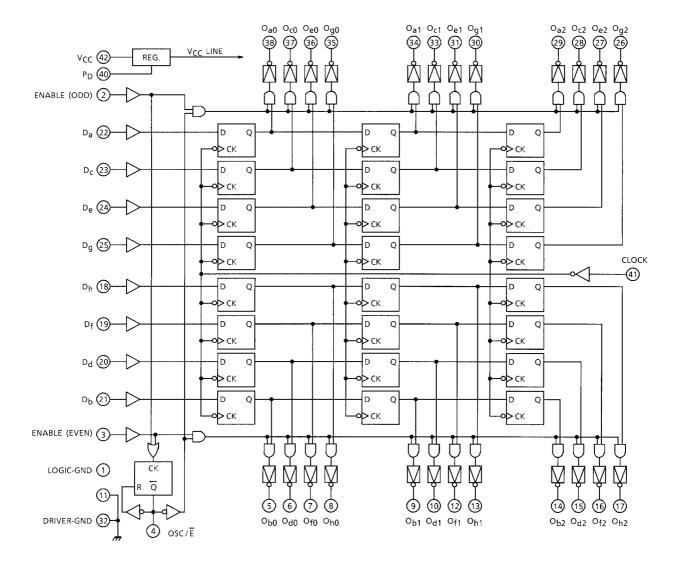


Weight: 6.37 g (Typ.)

## **PIN CONNECTION (TOP VIEW)**



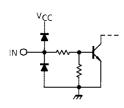
## **BLOCK DIAGRAM**

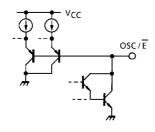


# INPUT EQUIVALENT CIRCUIT

# OSC / E TERMINAL EQUIVALENT CIRCUIT

## OUTPUT EQUIVALENT CIRCUIT





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## **TRUTH TABLE A**

P <sub>D</sub>	OSC/E	E (ODD)	E (EVEN)	O (ODD)	O (EVEN)	COMMENT
L	(Note 1)	(Note 1)	(Note 1)	OFF	OFF	I <sub>CC</sub> < 10 μA
Н	(Note 1)	L	L	OFF	OFF	_
Н	L	н	L	D	OFF	_
Н	L	L	Н	OFF	D	_
Н	L	Н	Н	D	D	_
Н	CR	<b>↑</b>	L	D	OFF	
Н	CR	L	<b>↑</b>	OFF	D	OUTPUT ON time is according to CR constant.
Н	CR	<b>↑</b>	<b>↑</b>	D	D	
Н	CR	Н	(Note 1)	OFF	OFF	_
Н	CR	(Note 1)	Н	OFF	OFF	_

Note: If "H" level power is applied by force, OSC / E terminal may be destructed and therefore, it should be used with CR added or grounded.

Note 1: "H" or "L"

## **TRUTH TABLE B**

P <sub>D</sub>	CLOCK	D <sub>X</sub>	$Q_{X0}$	Q <sub>X1</sub>	Q <sub>X2</sub>	COMMENT
L	(Note)	(Note)	OFF	OFF	OFF	_
Н	<b>↑</b>	L	OFF	Q <sub>X0</sub>	Q <sub>X1</sub>	DATA SHIFT
Н	<b>↑</b>	Н	ON	Q <sub>X0</sub>	Q <sub>X1</sub>	DATA GIIII I
Н	<b>↓</b>	(Note)	$Q_{X0}$	Q <sub>X1</sub>	Q <sub>X2</sub>	
Н	L	$\uparrow\downarrow$	Q <sub>X0</sub>	Q <sub>X1</sub>	Q <sub>X2</sub>	NO CHANGE
Н	Н	$\uparrow\downarrow$	$Q_{X0}$	Q <sub>X1</sub>	Q <sub>X2</sub>	

Note: "H" or "L"

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## **MAXIMUM RATING (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Supply Voltage	V <sub>CC</sub>	7.0	V	
Output Voltage	V <sub>OUT</sub>	30	V	
Output Current	I <sub>OUT1</sub> (Note)	80	mA / ch	
Output Guiterit	I <sub>OUT2</sub> (Note)	150	IIIA / CII	
Input Voltage	V <sub>IN</sub>	V <sub>CC</sub>	V	
External Resistor	R <sub>EXT</sub>	1000	kΩ	
External Capacitor	C <sub>EXT</sub>	50	μF	
Max. Operating Frequency	f <sub>MAX</sub>	750	kHz	
Power Dissipation	$P_{D}$	1.6	W	
Operating Temperature	T <sub>opr</sub>	0~75	°C	
Storage Temperature	T <sub>stg</sub>	-55~150	°C	

Note: I<sub>OUT 1</sub>: DC, I<sub>OUT 2</sub>: Duty-10%

## **RECOMMENDED OPERATING CONDITION (Ta = 0 ~ 70°C)**

CHARACTERISTIC	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Supply Voltage	V <sub>CC</sub>	_	4.5	5.0	5.5	V
Output Voltage	V <sub>OUT</sub>	_	0	_	28	V
Output Current	I <sub>OUT1</sub>	_	0	_	80	mA
Output Current	I <sub>OUT2</sub>	Duty 20%	0	_	130	
Input Voltage	V <sub>IN</sub>	_	0	_	V <sub>CC</sub>	V
External Resistor	R <sub>EXT</sub>	_	0.1	_	500	kΩ
External Capacitor	C <sub>EXT</sub>	_	_	_	50	μF
Max. Operating Frequency	f <sub>MAX</sub>	_	_	_	400	kHz
Clock Pulse Width	t <sub>w</sub> ( CK )	_	300	_	_	
Clock Fulse Width	t <sub>w</sub> ( $\overline{CK}$ )	_	2.2	_	_	μs
Data Setup Time	t <sub>setup</sub>	_	0.0	_	_	μs
Data Hold Time	t <sub>hold</sub>	_	1.0	_	_	μs
Power Dissipation	PD	T <sub>j</sub> = 130°C, on PCB	_	_	1.5	W

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## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION		MIN	TYP.	MAX	UNIT	
Input Voltage	"H" Level	V <sub>IH</sub>	_	_		2.0	_	V <sub>CC</sub>	V	
input voitage	"L" Level	V <sub>IL</sub>	_		_	0	_	0.6	V	
	"H" Level	,	_	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 2.4 V		_	0.12	0.2	- mA	
Input Current	II Level	I <sub>IH</sub>		V <sub>CC</sub> = 5	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V		0.32	0.5		
	"L" Level	I <sub>IL</sub>	_	V <sub>CC</sub> = 5	.5 V, V <sub>IN</sub> = 0.3 V	_	_	30	μA	
Output Leak Current		Гон	_	V <sub>CC</sub> = 4.5 V, V <sub>OUT</sub> = 28 V		_	_	30	μA	
Outside Outside Inc.		V		V <sub>CC</sub> = 4.5 V, I <sub>OUT</sub> = 60 mA		_	0.9	1.15	V	
Output Saturation		$V_{OL}$		V <sub>CC</sub> = 4.5 V, I <sub>OUT</sub> = 120 mA		_	1.1	1.5	v	
		Icc	_			P <sub>D</sub> = GND	_	_	10	μA
Supply Current		I <sub>CC (ON)</sub>		_	V <sub>CC</sub> = 5.5 V	P <sub>D</sub> = GND ALL OUTPUT "ON"	_	12	20	A
		I <sub>CC (OFF)</sub>		0.0 V	P <sub>D</sub> = GND ALL OUTPUT "OFF"	_	9.5	16	- mA	
Innut Voltage	"H" Level	V <sub>TH</sub> +			<u> </u>	2.5	2.8	3.1	V	
Input Voltage	"L" Level	V <sub>TH</sub> -	] _		_	1.2	1.4	1.6	v	
Hysteresis Voltage		V <sub>H</sub>	_		_	_	1.4	_	V	

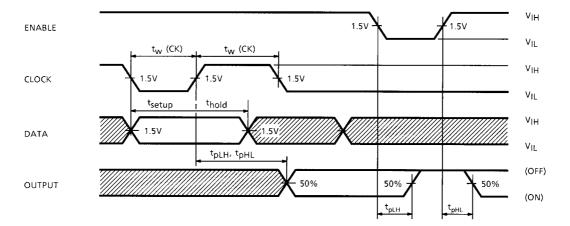
## SWITCHING CHARACTERISTICS (Ta = 25°C, $V_{CC}$ = 5.0 V)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Max. Operating Frequency		$f_{MAX}$			500	850	_	kHz
	CK-OUT			$R_L = 68 \Omega$ , $C_L = 15 pF$ $V_{IH} = 3.0 V$ , $V_{IL} = 0 V$	_	0.7	1.3	
Propagation	E-OUT	4			_	5.5	10	
"H" Level	OSC-OUT	t <sub>pLH</sub>			_	7.5	13	
	P <sub>D</sub> -OUT				_	9	30	μs
	CK-OUT				_	0.8	1.3	
Delay Time "L" Level	E-OUT	t <sub>pHL</sub>			_	0.6	1.3	
	OSC-OU T				_	0.8	1.3	
	CLOCK	t <sub>w</sub> MIN			_	0.06	0.1	- μs
Min. Pulse Width	CLOCK				_	1.1	1.85	
win. Puise width	ENABLE				_	0.1	0.2	
	ENABLE				_	1.0	2.0	
Cat I la Tima	CK-DATA	t <sub>setup</sub>			_	-0.2	0	μs
Set Up Time	P <sub>D</sub>				_	-0.22	0.8	
Data Hold Time		t <sub>hold</sub>			_	0.15	0.5	μs
Max. Clock Rise Time		t <sub>r</sub>			_	_	5	μs
Max. Clock Fall Time		t <sub>f</sub>			_	_	5	ms
Enable Output Pulse Width		t <sub>w</sub> ON	_	$R_{EXT}$ = 10 kΩ, $C_{EXT}$ = 10 μF	_	3	_	ms

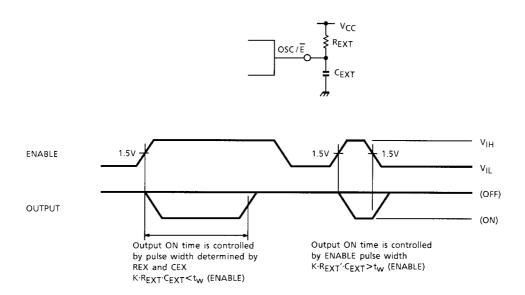
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## SWITCHING CHARACTERISTICS TEST CONDITION

## A. Timing waveform (OSC / $\bar{E}$ = GND)



## B. Usage of OSC / E terminal



## **PRECAUTIONS for USING**

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

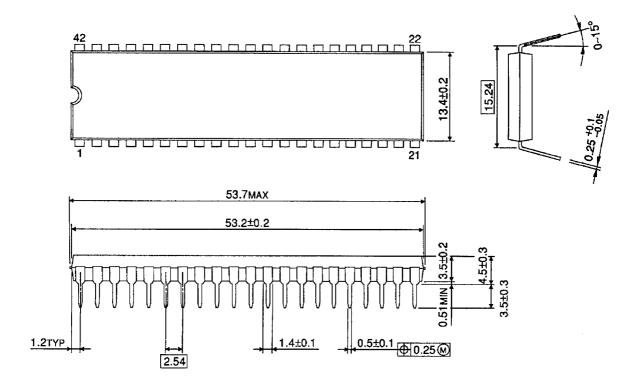
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

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## **PACKAGE DIMENSIONS**

DIP42-P-600-2.54

Unit: mm



Weight: 6.37 g (Typ.)

#### **RESTRICTIONS ON PRODUCT USE**

000707EBA

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